

# DSA12X1

## High Performance CMOS MEMS Oscillator for Automotive

#### Features

- Automotive AEC-Q100 Qualified
- · Wide Frequency Range: 2.5 MHz to 170 MHz
- Very Low RMS Phase Jitter: <650 fs (typ.)
- High Stability: ±20 ppm, ±25 ppm, ±50 ppm
- Wide Temperature Range:
  - Automotive Grade 1: -40°C to +125°C
  - Automotive Grade 2: -40°C to +105°C
  - Automotive Grade 3: -40°C to +85°C
- Small Industry-Standard Footprints
  - 2.5 mm x 2.0 mm
  - 3.2 mm x 2.5 mm
  - 5.0 mm x 3.2 mm
  - 7.0 mm x 5.0 mm
- · Excellent Shock and Vibration Immunity
- Qualified to MIL-STD-883
- · High Reliability
- 20x Better MTF than Quartz Oscillators
- Supply Range of 2.25V to 3.63V
- Standby, Frequency Select, and Output Enable Functions
- · Lead-Free and RoHS-Compliant

#### **Applications**

- Automotive Infotainment
- Automotive ADAS
- In-Vehicle Networking, CAN Bus, Ethernet

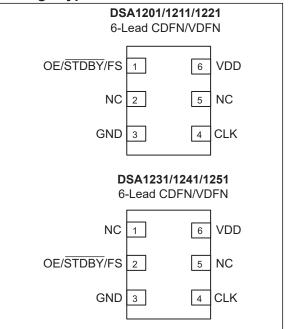
#### **General Description**

The DSA12x1 family of high performance oscillators utilizes the latest generation of silicon MEMS technology that reduces close-in noise and provides excellent jitter and stability over a wide range of supply voltages and temperatures. By eliminating the need for quartz or SAW technology, MEMS oscillators significantly enhance reliability and accelerate product development, while meeting stringent clock performance criteria for automotive applications.

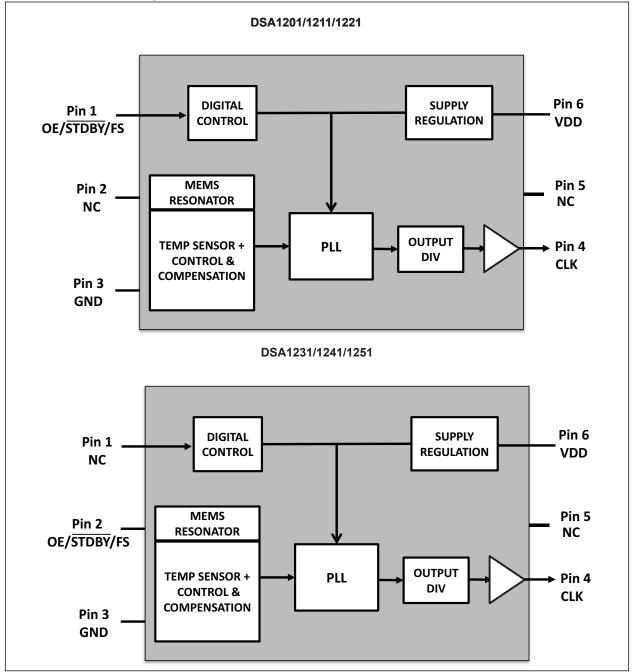
The DSA12x1 family features a control function on pin 1 or pin 2 that permits either a standby feature (complete power down when STDBY is low), output enable (output is tri-stated with OE low), or a frequency select (choice of two frequencies selected by FS high/low). See the Product Identification System section for detailed information.

All oscillators are available in industry-standard packages, including the small 2.5 mm x 2.0 mm, and are "drop-in" replacements for standard 4-pin and 6-pin CMOS quartz crystal oscillators.

#### **Package Types**



#### **Functional Block Diagrams**



## 1.0 ELECTRICAL CHARACTERISTICS

## Absolute Maximum Ratings †

Supply Voltage	–0.3V to +4.0V
Input Voltage	
ESD Protection (HBM)	
ESD Protection (MM)	
ESD Protection (CDM)	

**† Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

## **ELECTRICAL CHARACTERISTICS**

**Electrical Characteristics:**  $V_{DD} = 2.5V \pm 10\%$  or  $3.3V \pm 10\%$ ;  $T_A = -40$ °C to  $\pm 125$ °C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Supply Voltage	V <sub>DD</sub>	2.25		3.63	V	Note 1
Supply Current		_	27	_	mA	Output enabled, CMOS (no load), f <sub>OUT</sub> = 100 MHz
	I <sub>DD</sub>		23	_	IIIA	Output disabled (tri-state), f <sub>OUT</sub> = 100 MHz
Standby Current	I <sub>STDBY</sub>	_	2.5	5	μA	Input pin = $\overline{\text{STDBY}}$ = Asserted (V <sub>DD</sub> = 3.3V)
				±20		Includes frequency variations due
Frequency Stability	Δf			±25	ppm	to initial tolerance, temp., and
		—		±50		power supply voltage
Aging	Δf			±5	ppm	First year @ 25°C
		—		±1	ppin	Per year after first year
Startup Time	t <sub>SU</sub>	_	5.5	6	ms	From 90% V <sub>DD</sub> to valid clock output, T = +25°C, Note 2
	V <sub>IH</sub>	0.75 x V <sub>DD</sub>	_	_	V	Input logic high
Input Logic Levels	V <sub>IL</sub>	_		0.25 x V <sub>DD</sub>		Input logic low
Output Disable Time	t <sub>DA</sub>	—		25	ns	Note 3
Output Englis Time		—		6	ms	STDBY
Output Enable Time	t <sub>EN</sub>	—		350	ns	OE
Enable Pull-Up Resistor	_	—	1.5	_	MΩ	Pull-up resistor on pin 1, Note 4
Frequency	f <sub>0</sub>	2.5		170	MHz	—
Output Logic Level High	V <sub>OH</sub>	0.8 x V <sub>DD</sub>	_	_	V	I = $\pm 12$ mA (High Drive) I = $\pm 10$ mA (Standard Drive)
Output Logic Level Low	V <sub>OL</sub>	_	_	0.2 x V <sub>DD</sub>	V	I = ±8 mA (Mid Drive) I = ±6 mA (Low Drive)
		—	1.3	_		Standard Drive Strength
Output Transition Time, Rise	+	_	1.2			High Drive Strength
20% to 80%;C <sub>L</sub> =15 pF	t <sub>R</sub>	—	1.6		ns	Mid Drive Strength
		_	2.4			Low Drive Strength

## **ELECTRICAL CHARACTERISTICS (CONTINUED)**

**Electrical Characteristics:**  $V_{DD}$  = 2.5V ±10% or 3.3V ±10%;  $T_A$  = -40°C to +125°C, unless noted.

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
			1.3			Standard Drive Strength
Output Transition Time, Fall	+		1.1			High Drive Strength
20% to 80%;C <sub>L</sub> =15 pF	t <sub>F</sub>	_	1.8	_	ns	Mid Drive Strength
		_	2.4	_		Low Drive Strength
Output Duty Cycle	SYM	45	_	55	%	—
Period Jitter, Peak-to-Peak	J <sub>PTP</sub>	_	25	_	ps	f <sub>OUT</sub> = 100 MHz, High Drive
Cycle-to-Cycle Jitter, Peak	J <sub>CC</sub>	_	22	_	ps	f <sub>OUT</sub> = 100 MHz, High Drive
Integrated Phase Noise (Random)	J <sub>PH</sub>		0.65		ps <sub>RMS</sub>	12 kHz to 20 MHz @ 100 MHz, T <sub>A</sub> = +105°C

Note 1:  $V_{DD}$  pin should be filtered with a 0.1  $\mu$ F capacitor.

2:  $t_{SU}$  is the time to 100 ppm stable output frequency after V<sub>DD</sub> is applied and outputs are enabled.

3:  $t_{DA}$ : See the Output Waveform and the Test Circuit sections for more information.

4: Output is enabled if pad is floated (not connected).

## **TEMPERATURE SPECIFICATIONS Note 1**

Parameters	Symbol	Min.	Тур.	Max.	Units	Conditions
Temperature Ranges						
Maximum Junction Temperature	TJ		—	+150	°C	_
Storage Temperature Range	Τ <sub>S</sub>	-55	_	+150	°C	—
Lead Temperature	—		_	+260	°C	Soldering, 40s

Note 1: The maximum allowable power dissipation is a function of ambient temperature, the maximum allowable junction temperature and the thermal resistance from junction to air (i.e., T<sub>A</sub>, T<sub>J</sub>, θ<sub>JA</sub>). Exceeding the maximum allowable power dissipation will cause the device operating junction temperature to exceed the maximum +150°C rating. Sustained junction temperatures above +150°C can impact the device reliability.

## 2.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 2-1.

#### TABLE 2-1: DSA1201/1211/1221 PIN FUNCTION TABLE

Pin Number	DSA	1201	DSA	1211	DSA1221		
	Pin Name	Description	Pin Name	Description	Pin Name	Description	
1	STDBY	Standby.	FS	Frequency select.	OE	Output enable.	
2	NC	No connect.	NC	No connect.	NC	No connect.	
3	GND	Power supply ground.	GND	Power supply ground.	GND	Power supply ground.	
4	CLK	Clock output.	CLK	Clock output.	CLK	Clock output.	
5	NC	No connect.	NC	No connect.	NC	No connect.	
6	VDD	Power supply.	VDD	Power supply.	VDD	Power supply.	

#### TABLE 2-2: DSA1231/1241/1251 PIN FUNCTION TABLE

Pin Number	DSA	1231	DSA	1241	DSA1251		
Pill Nulliber	Pin Name	Description	Pin Name Descriptio		Pin Name	Description	
1	NC	No connect.	NC	No connect.	NC	No connect.	
2	STDBY	Standby.	FS	Frequency select.	OE	Output enable.	
3	GND	Power supply ground.	GND	Power supply ground.	GND	Power supply ground.	
4	CLK	Clock output.	CLK	Clock output.	CLK	Clock output.	
5	NC	No connect.	NC	No connect.	NC	No connect.	

#### 2.1 Standby

Complete power down when  $\overline{\text{STDBY}}$  is low.

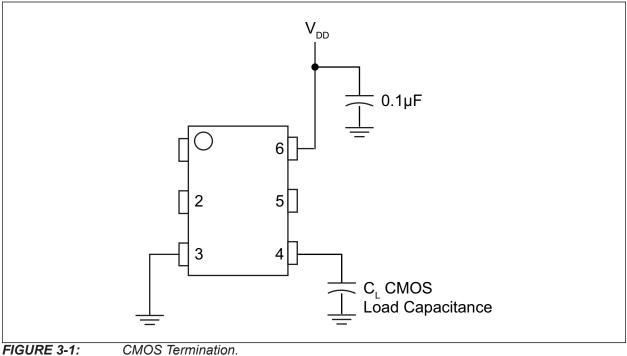
#### 2.2 Frequency Select

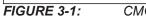
Two frequencies may be chosen, selected by FS = High or Low. Please use the ClockWorks tool to customize frequencies.

#### 2.3 Output Enable

Output buffers (only) are tri-stated when OE is low.

#### **TERMINATION SCHEME** 3.0





## 4.0 OUTPUT WAVEFORM

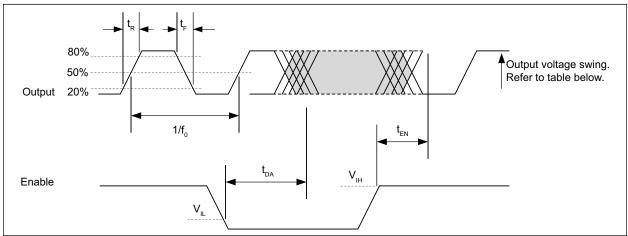
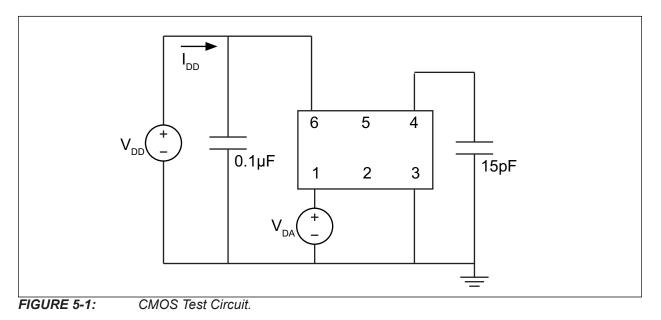


FIGURE 4-1: CMOS Output Waveform.

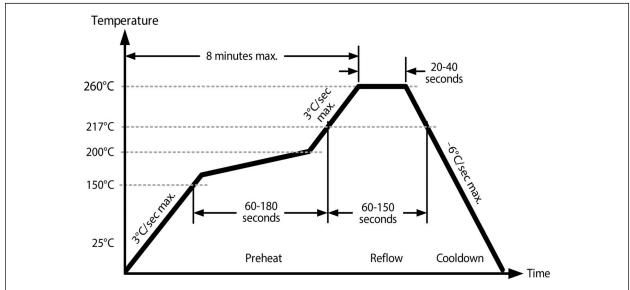
### TABLE 4-1: OUTPUT VOLTAGE SWING BY LOGIC TYPE

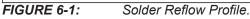
	Output Logic Protocol	Typical Peak-to-Peak Output Swing					
ľ	CMOS	V <sub>OH</sub> , V <sub>OL</sub>					

## 5.0 TEST CIRCUIT



## 6.0 SOLDER REFLOW PROFILE

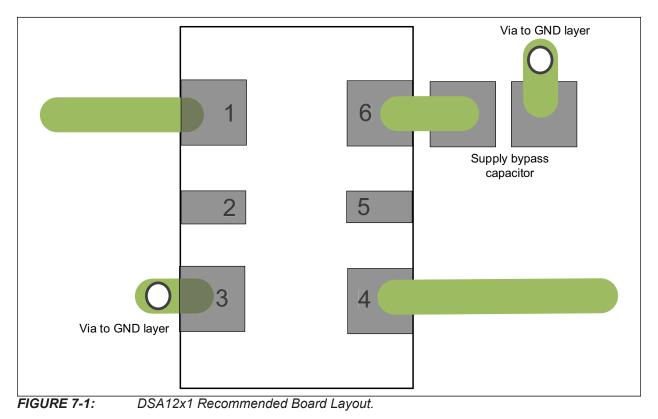




### TABLE 6-1: SOLDER REFLOW

MSL 1 @ 260°C Refer to JSTD-020C								
Ramp-Up Rate (200°C to Peak Temp.)	3°C/sec. max.							
Preheat Time 150°C to 200°C	60 to 180 sec.							
Time Maintained above 217°C	60 to 150 sec.							
Peak Temperature	255°C to 260°C							
Time within 5°C of Actual Peak	20 to 40 sec.							
Ramp-Down Rate	–6°C/sec. max.							
Time 25°C to Peak Temperature	8 minutes max.							

## 7.0 BOARD LAYOUT (RECOMMENDED)



#### 8.0 PHASE NOISE



FIGURE 8-1: DSA12x1 Phase Noise at 25 MHz.

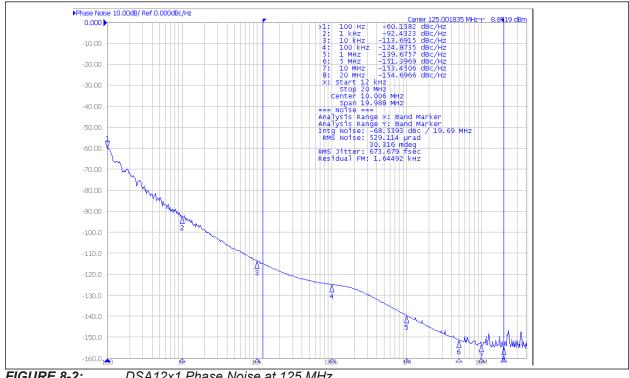
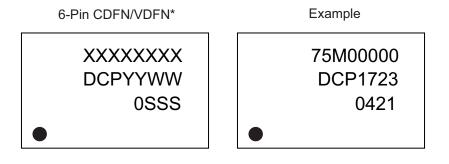


FIGURE 8-2:

DSA12x1 Phase Noise at 125 MHz.

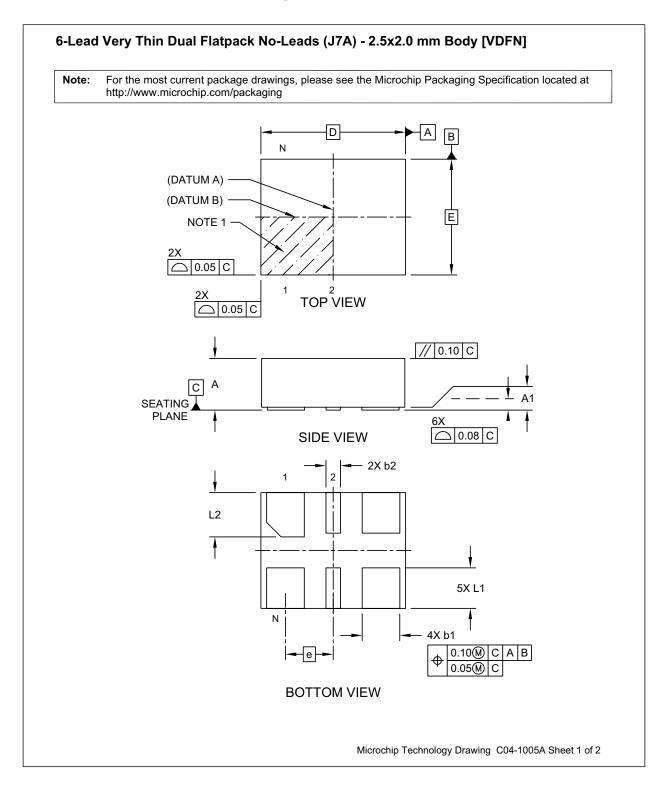
## 9.0 PACKAGING INFORMATION

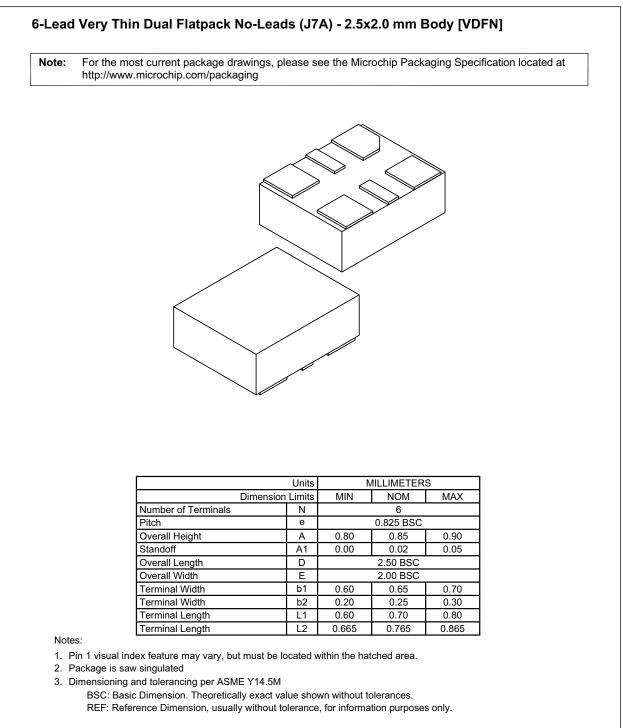
## 9.1 Package Marking Information



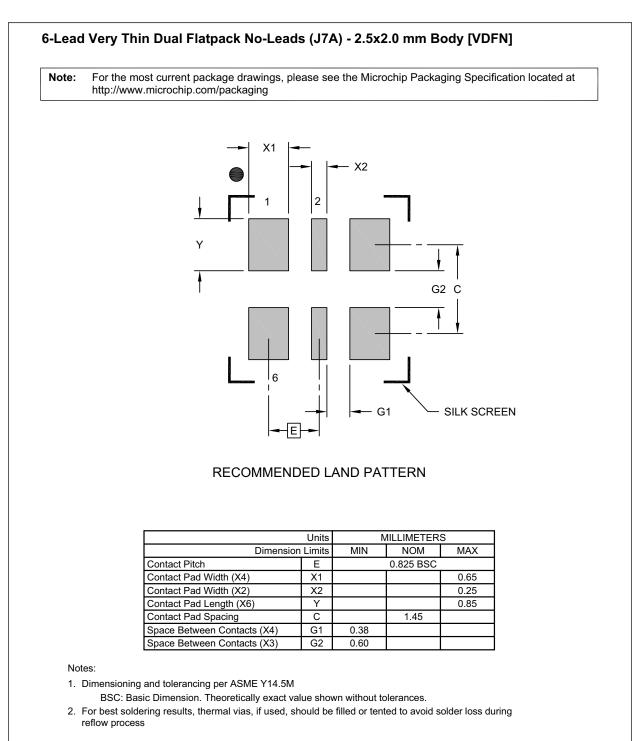
Legend	1: XXX Y YY WW SSS (€3) * •, ▲, ▼ mark).	Product code or customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC <sup>®</sup> designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package. Pin one index is identified by a dot, delta up, or delta down (triangle
Note:	be carried characters the corpora	t the full Microchip part number cannot be marked on one line, it will l over to the next line, thus limiting the number of available for customer-specific information. Package may or may not include ate logo. () and/or Overbar ( <sup>-</sup> ) symbol may not be to scale.

## 6-Lead VDFN 2.5 mm x 2.0 mm Package Outline and Recommended Land Pattern



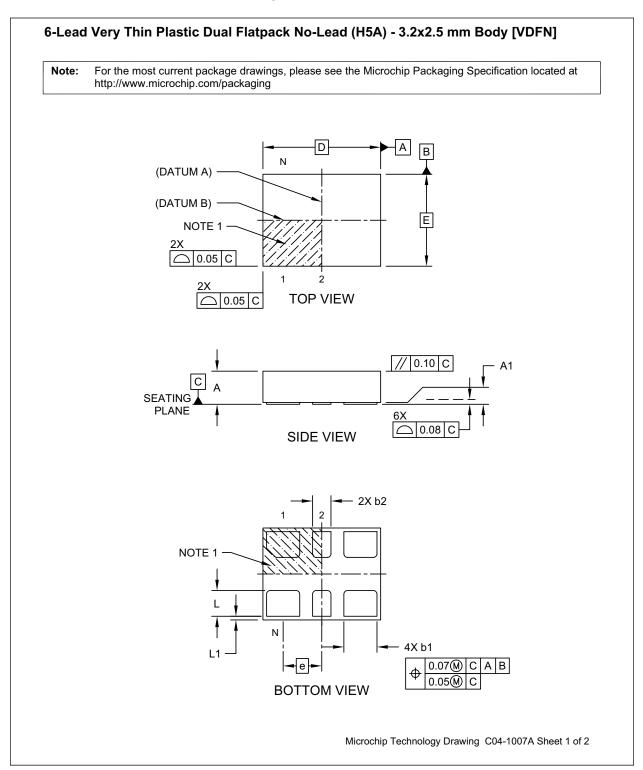


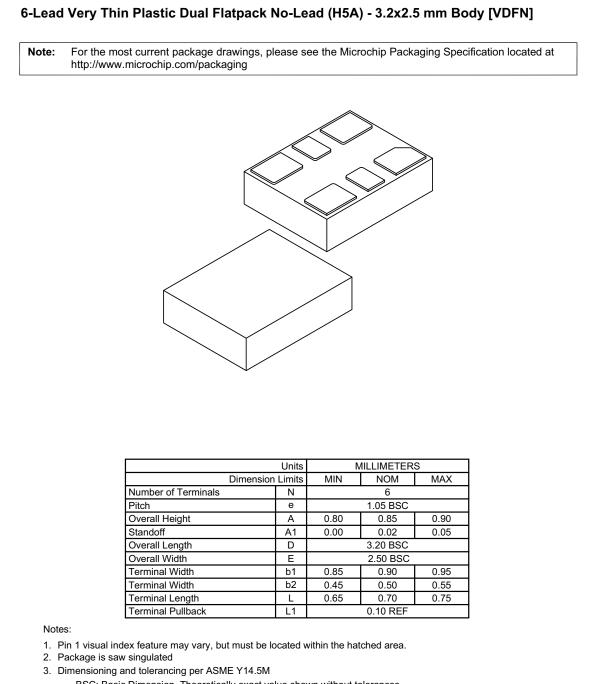
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Microchip Technology Drawing C04-3005A

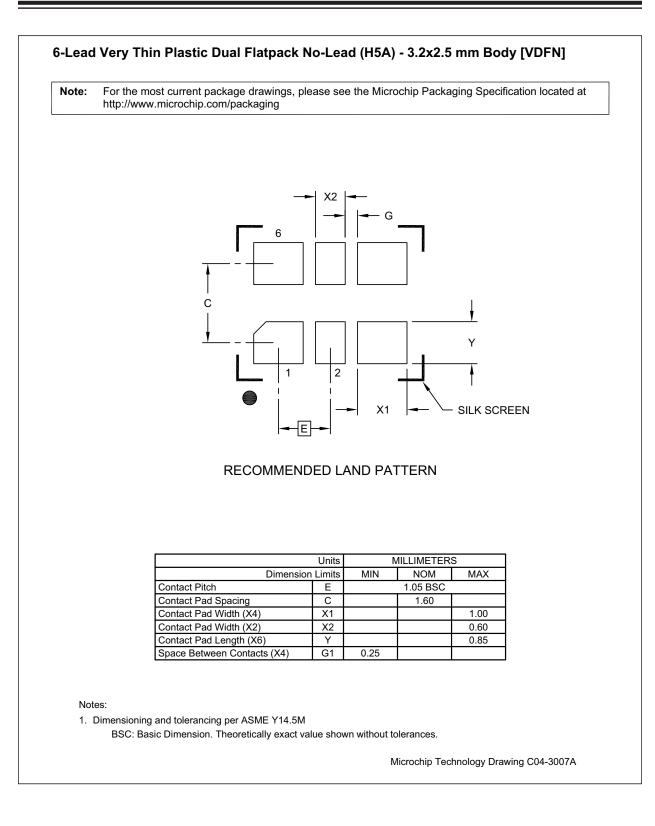
#### 6-Lead VDFN 3.2 mm x 2.5 mm Package Outline and Recommended Land Pattern



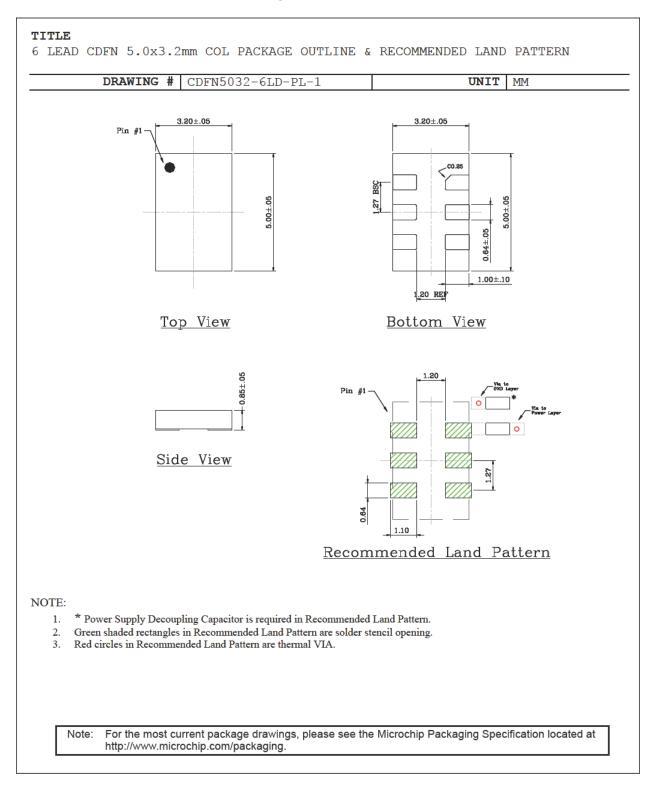


BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

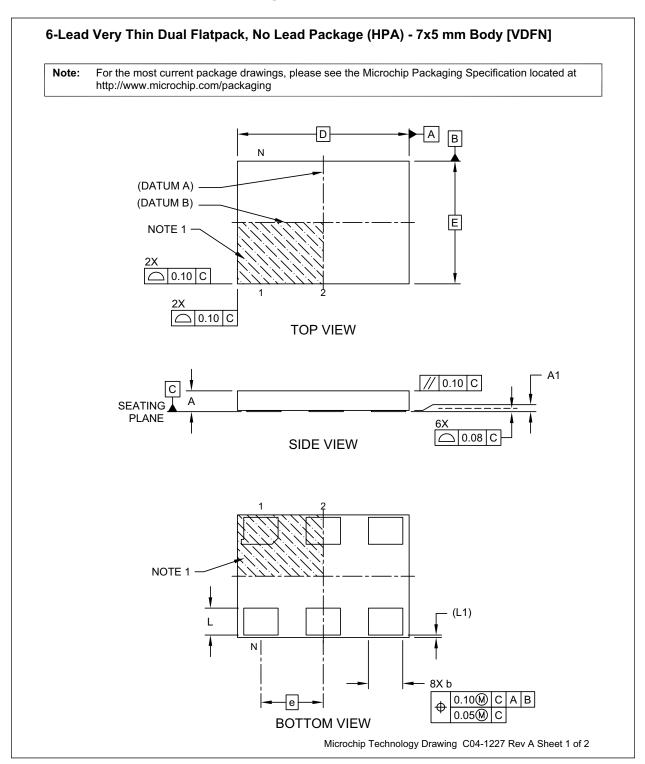
Microchip Technology Drawing C04-1007A Sheet 2 of 2

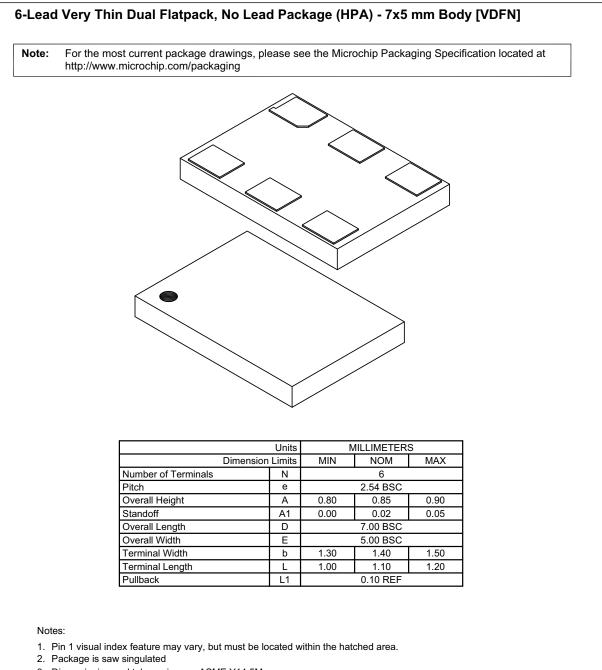


#### 6-Lead CDFN 5.0 mm x 3.2 mm Package Outline and Recommended Land Pattern



#### 6-Lead VDFN 7.0 mm x 5.0 mm Package Outline and Recommended Land Pattern

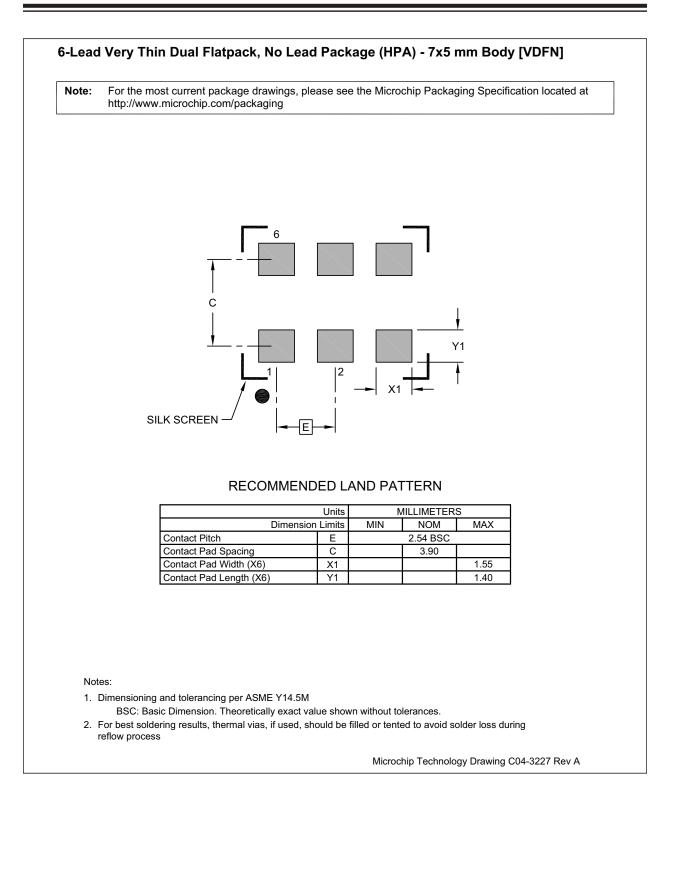




3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-1227 Rev A Sheet 2 of 2



## DSA12X1

NOTES:

## APPENDIX A: REVISION HISTORY

## Revision A (July 2020)

• Initial release of DSA12x1 as Microchip data sheet DS20006385A.

## DSA12X1

NOTES:

## **PRODUCT IDENTIFICATION SYSTEM**

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO. X	, 	×	¥	2	×		¥	<u>-X</u>	XXXXXXX	¥	<u>xxx</u>		
Device Con Pi		Outpu Forma		Tempe	erature	Freq.	 Stabil	ity Outpı	ut Frequency	Media Type	Automotive Suffix		
								Example	s:				
Device:	DS/	A12:	High Performan Automotive	ice CMOS	MEMS C	Oscillato	or for	a) DSA12	Pull-up, CMC	S Output, 7			
Control Pin: Output Format:	0 1 2 3 4 5	= = =	Pin 1 STDBY with Pin 1 Frequency Pin 1 OE with Pu Pin 2 STDBY with Pin 2 Frequency Pin 2 OE with Pu CMOS	Select with Ill-up h Pull-up Select with				,	Frequency, 1 11CL3-C0013V with Pull-up, -40°C to +10 24 MHz & 25 21BI2-19M5000 CMOS Outpu	,000/Reel, S AO: Pin 1 Fi CMOS Outp 5°C, ±20 pp MHz, Bulk, 00BVAO: Pir it, 5x3.2, -4 5 MHz Outp	n, 25 MHz Output Standard Automotive requency Select but, 3.2x2.5 VDFN, m, Frequency Select Standard Automotiv n 1 OE with Pull-up, 0°C to +85°C, but Frequency,		
Package:	N B C D	= = =	7 mm x 5 mm 6- 5 mm x 3.2 mm ( 3.2 mm x 2.5 mm 2.5 mm x 2 mm (	6-Lead CD n 6-Lead V	)FN /DFN			d) DSA12	n 2 OE with .5x2 VDFN, m, 55.82 MHz Outpu Standard Automotive				
Temperature:	A L I	= =	-40°C to +125°C -40°C to +105°C -40°C to +85°C	(Automot	ive Grad	e 2)		e) DSA12	STDBY with x5 VDFN, n, Frequency Select 3,000/Reel, Standard				
Frequency Stability:	1 2 3	= =	±50 ppm ±25 ppm ±20 ppm					Automotiv Note 1:	Tape and Reel identifier only appears in the catalog part number description. This identi				
Output Frequency:	xxM xxxl	Ixxxxx = Mxxxx = CCC =	<ul> <li>&lt;10 MHz</li> <li>&lt;100 MHz</li> <li>&gt;100 MHz</li> <li>&gt;100 MHz</li> <li>with Frequency</li> <li>TimeFlash</li> </ul>	Select					used for ordering purposes and is not pr the device package. Check with your Mi Sales Office for package availability with Tape and Reel option.				
Media Type:	 bla T B		Bulk 1,000/Reel 3,000/Reel										
Automotive Suffix:	VXX	< =	Automotive suffix Microchip. Defau automotive part										
Please visit the configure the par http://clockworks	t nui	mber fo	or customized										

## DSA12X1

NOTES:

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